

	Search Text	DBs
1	(264/271.1,272.11,272.17,273,279.1) .CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
2	(438/112,124,127).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
3	(438/108,118,122,123).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
4	2 and 3 and 4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
5	5 and (barrier near5 layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
6	flip near5 chip	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
7	L7 and (attach\$3 same chip same device)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
8	8 and (barrier near5 layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
9	5 and 9	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
10	(direct near5 chip near5 attach\$3 same device)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB
11	11 and (barrier near5 layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB